

# NLX3G16

## Triple Non-Inverting Buffer

The NLX3G16 MiniGate™ is an advanced high-speed CMOS triple non-inverting buffer in ultra-small footprint.

The NLX3G16 input and output structures provide protection when voltages up to 7.0 V are applied, regardless of the supply voltage.

### Features

- High Speed:  $t_{PD} = 1.8 \text{ ns}$  (Typ) @  $V_{CC} = 5.0 \text{ V}$
- Designed for 1.65 V to 5.5 V  $V_{CC}$  Operation
- Low Power Dissipation:  $I_{CC} = 1 \mu\text{A}$  (Max) at  $T_A = 25^\circ\text{C}$
- 24 mA Balanced Output Source and Sink Capability
- Balanced Propagation Delays
- Overvoltage Tolerant (OVT) Input and Output Pins
- Ultra-Small Packages
- These are Pb-Free Devices

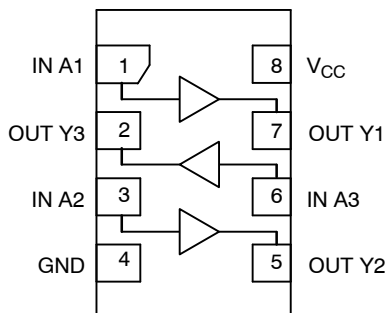


Figure 1. Pinout (Top View)

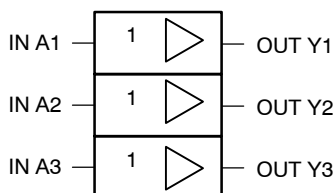


Figure 2. Logic Symbol

### PIN ASSIGNMENT

|   |        |
|---|--------|
| 1 | IN A1  |
| 2 | OUT Y3 |
| 3 | IN A2  |
| 4 | GND    |
| 5 | OUT Y2 |
| 6 | IN A3  |
| 7 | OUT Y1 |
| 8 | VCC    |

### FUNCTION TABLE

| A | Y |
|---|---|
| L | L |
| H | H |



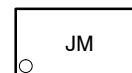
ON Semiconductor®

<http://onsemi.com>

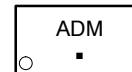
### MARKING DIAGRAMS



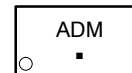
ULLGA8  
1.45 x 1.0  
CASE 613AA



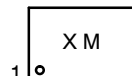
ULLGA8  
1.6 x 1.0  
CASE 613AB



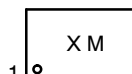
ULLGA8  
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CASE 613AC



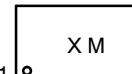
UDFN8  
1.45 x 1.0  
CASE 517BZ



UDFN8  
1.6 x 1.0  
CASE 517BY



UDFN8  
1.95 x 1.0  
CASE 517CA



J or AD = Specific Device Code  
M = Date Code  
▪ = Pb-Free Package

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

# NLX3G16

## MAXIMUM RATINGS

| Symbol        | Parameter                                                           | Value                | Unit |
|---------------|---------------------------------------------------------------------|----------------------|------|
| $V_{CC}$      | DC Supply Voltage                                                   | -0.5 to +7.0         | V    |
| $V_{IN}$      | DC Input Voltage                                                    | -0.5 to +7.0         | V    |
| $V_{OUT}$     | DC Output Voltage                                                   | -0.5 to +7.0         | V    |
| $I_{IK}$      | DC Input Diode Current<br>$V_{IN} < GND$                            | -50                  | mA   |
| $I_{OK}$      | DC Output Diode Current<br>$V_{OUT} < GND$                          | -50                  | mA   |
| $I_O$         | DC Output Source/Sink Current                                       | $\pm 50$             | mA   |
| $I_{CC}$      | DC Supply Current Per Supply Pin                                    | $\pm 100$            | mA   |
| $I_{GND}$     | DC Ground Current per Ground Pin                                    | $\pm 100$            | mA   |
| $T_{STG}$     | Storage Temperature Range                                           | -65 to +150          | °C   |
| $T_L$         | Lead Temperature, 1 mm from Case for 10 Seconds                     | 260                  | °C   |
| $T_J$         | Junction Temperature Under Bias                                     | 150                  | °C   |
| MSL           | Moisture Sensitivity                                                | Level 1              |      |
| $F_R$         | Flammability Rating Oxygen Index: 28 to 34                          | UL 94 V-0 @ 0.125 in |      |
| $I_{LATCHUP}$ | Latchup Performance Above $V_{CC}$ and Below GND at 125 °C (Note 5) | $\pm 500$            | mA   |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace no air flow.
2. Tested to EIA/JESD22-A114-A.
3. Tested to EIA/UESD22-A115-A.
4. Tested to JESD22-C101-A.
5. Tested to EIA / JESD78.

## RECOMMENDED OPERATING CONDITIONS

| Symbol              | Parameter                                                                                                                                                 | Min              | Max                 | Unit |
|---------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|---------------------|------|
| $V_{CC}$            | Positive DC Supply Voltage                                                                                                                                | 1.65             | 5.5                 | V    |
| $V_{IN}$            | Digital Input Voltage                                                                                                                                     | 0                | 5.5                 | V    |
| $V_{OUT}$           | Output Voltage                                                                                                                                            | 0                | 5.5                 | V    |
| $T_A$               | Operating Free-Air Temperature                                                                                                                            | -55              | +125                | °C   |
| $\Delta t/\Delta V$ | Input Transition Rise or Fall Rate<br>$V_{CC} = 1.8 V \pm 0.18$<br>$V_{CC} = 2.5 V \pm 0.2 V$<br>$V_{CC} = 3.3 V \pm 0.3 V$<br>$V_{CC} = 5.0 V \pm 0.5 V$ | 0<br>0<br>0<br>0 | 20<br>20<br>10<br>5 | ns/V |

# NLX3G16

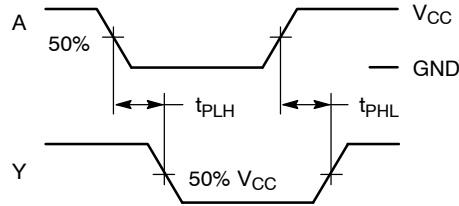
## DC ELECTRICAL CHARACTERISTICS

| Symbol           | Parameter                        | Conditions                                                                        | V <sub>CC</sub><br>(V) | T <sub>A</sub> = 25 °C |                 |                        | T <sub>A</sub> = +85°C |                        | T <sub>A</sub> = -55°C to +125°C |                        | Unit |
|------------------|----------------------------------|-----------------------------------------------------------------------------------|------------------------|------------------------|-----------------|------------------------|------------------------|------------------------|----------------------------------|------------------------|------|
|                  |                                  |                                                                                   |                        | Min                    | Typ             | Max                    | Min                    | Max                    | Min                              | Max                    |      |
| V <sub>IH</sub>  | Low-Level Input Voltage          |                                                                                   | 1.65 to 5.5            | 0.70 x V <sub>CC</sub> |                 |                        | 0.70 x V <sub>CC</sub> |                        |                                  |                        | V    |
| V <sub>IL</sub>  | Low-Level Input Voltage          |                                                                                   | 1.65 to 5.5            |                        |                 | 0.30 x V <sub>CC</sub> |                        | 0.30 x V <sub>CC</sub> |                                  | 0.30 x V <sub>CC</sub> | V    |
| V <sub>OH</sub>  | High-Level Output Voltage        | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>I <sub>OH</sub> = -100 µA | 1.65 to .5             | V <sub>CC</sub> - 0.1  | V <sub>CC</sub> |                        | V <sub>CC</sub> - 0.1  |                        | V <sub>CC</sub> - 0.1            |                        | V    |
|                  |                                  | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>I <sub>OH</sub> = -4 mA   | 1.65                   | 1.4                    | 1.50            |                        | 1.4                    |                        | 1.4                              |                        |      |
|                  |                                  | I <sub>OH</sub> = -8 mA                                                           | 2.3                    | 1.9                    | 2.1             |                        | 1.9                    |                        | 1.9                              |                        |      |
|                  |                                  | I <sub>OH</sub> = -12 mA                                                          | 2.7                    | 2.2                    | 2.4             |                        | 2.2                    |                        | 2.2                              |                        |      |
|                  |                                  | I <sub>OH</sub> = -16 mA                                                          | 3.0                    | 2.4                    | 2.7             |                        | 2.4                    |                        | 2.4                              |                        |      |
|                  |                                  | I <sub>OH</sub> = -24 mA                                                          | 3.0                    | 2.3                    | 2.5             |                        | 2.3                    |                        | 2.3                              |                        |      |
|                  |                                  | I <sub>OH</sub> = -32 mA                                                          | 4.5                    | 3.8                    | 4.0             |                        | 3.8                    |                        | 3.8                              |                        |      |
| V <sub>OL</sub>  | Low-Level Output Voltage         | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>I <sub>OL</sub> = 100 µA  | 1.65 - 5.5             |                        |                 | 0.1                    |                        | 0.1                    |                                  | 0.1                    | V    |
|                  |                                  | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>I <sub>OH</sub> = 4 mA    | 1.65                   |                        | 0.2             | 0.24                   |                        | 0.24                   |                                  | 0.24                   |      |
|                  |                                  | I <sub>OH</sub> = 8 mA                                                            | 2.3                    |                        | 0.2             | 0.3                    |                        | 0.3                    |                                  | 0.3                    |      |
|                  |                                  | I <sub>OH</sub> = 12 mA                                                           | 2.7                    |                        | 0.22            | 0.4                    |                        | 0.4                    |                                  | 0.4                    |      |
|                  |                                  | I <sub>OH</sub> = 16 mA                                                           | 3.0                    |                        | 0.28            | 0.4                    |                        | 0.4                    |                                  | 0.4                    |      |
|                  |                                  | I <sub>OH</sub> = 24 mA                                                           | 3.0                    |                        | 0.38            | 0.55                   |                        | 0.55                   |                                  | 0.55                   |      |
|                  |                                  | I <sub>OH</sub> = 32 mA                                                           | 4.5                    |                        | 0.42            | 0.55                   |                        | 0.55                   |                                  | 0.55                   |      |
| I <sub>IN</sub>  | Input Leakage Current            | 0 ≤ V <sub>IN</sub> ≤ 5.5 V                                                       | 0 to 5.5               |                        |                 | ±0.1                   |                        | ±1.0                   |                                  | ±1.0                   | µA   |
| I <sub>OFF</sub> | Power-Off Output Leakage Current | V <sub>IN</sub> or V <sub>OUT</sub> = 5.5 V                                       | 0                      |                        |                 | 1.0                    |                        | 10                     |                                  | 10                     | µA   |
| I <sub>CC</sub>  | Quiescent Supply Current         | 0 ≤ V <sub>IN</sub> ≤ V <sub>CC</sub>                                             | 5.5                    |                        |                 | 1.0                    |                        | 10                     |                                  | 10                     | µA   |

## AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 3.0$ nS)

| Symbol                   | Parameter                              | $V_{CC}$<br>(V) | Test Condition                                      | $T_A = 25^\circ\text{C}$ |         |     | $T_A = +85^\circ\text{C}$ |     | $T_A = -55^\circ\text{C to } +125^\circ\text{C}$ |     | Unit |
|--------------------------|----------------------------------------|-----------------|-----------------------------------------------------|--------------------------|---------|-----|---------------------------|-----|--------------------------------------------------|-----|------|
|                          |                                        |                 |                                                     | Min                      | Typ     | Max | Min                       | Max | Min                                              | Max |      |
| $t_{PLH}$ ,<br>$t_{PHL}$ | Propagation Delay Input A to Output    | 1.65–1.95       | $R_L = 1\text{ M}\Omega$ ,<br>$C_L = 15\text{ pF}$  | 1.8                      | 6.0     | 7.9 | 1.8                       | 8.8 | 1.8                                              | 12  | ns   |
|                          |                                        | 2.3–2.7         | $R_L = 1\text{ M}\Omega$ ,<br>$C_L = 15\text{ pF}$  | 1.0                      | 3.0     | 5.2 | 1.0                       | 5.8 | 1.0                                              | 9.1 |      |
|                          |                                        | 3.0–3.6         | $R_L = 1\text{ M}\Omega$ ,<br>$C_L = 15\text{ pF}$  | 0.8                      | 2.3     | 3.6 | 0.8                       | 4.0 | 0.8                                              | 6.5 |      |
|                          |                                        |                 | $R_L = 500\text{ }\Omega$ ,<br>$C_L = 50\text{ pF}$ | 1.2                      | 3.0     | 4.6 | 1.2                       | 5.1 | 1.2                                              | 7.6 |      |
|                          |                                        | 4.5–5.5         | $R_L = 1\text{ M}\Omega$ ,<br>$C_L = 15\text{ pF}$  | 0.5                      | 1.8     | 2.9 | 0.5                       | 3.2 | 0.5                                              | 5.5 |      |
|                          |                                        |                 | $R_L = 500\text{ }\Omega$ ,<br>$C_L = 50\text{ pF}$ | 0.8                      | 2.4     | 3.8 | 0.8                       | 4.2 | 0.8                                              | 6.4 |      |
| $C_{IN}$                 | Input Capacitance                      | 5.5             | $V_{IN} = 0\text{ V or } V_{CC}$                    |                          | 7.0     |     |                           |     |                                                  |     | pF   |
| $C_{PD}$                 | Power Dissipation Capacitance (Note 6) | 3.3<br>5.5      | 10 MHz<br>$V_{IN} = 0\text{ V or } V_{CC}$          |                          | 9<br>11 |     |                           |     |                                                  |     | pF   |

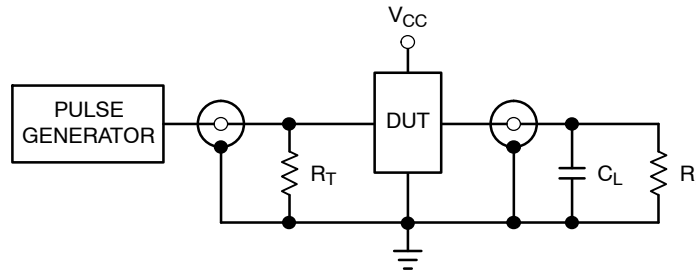
6.  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the dynamic operating current consumption without load. Average operating current can be obtained by the equation  $I_{CC(OPR)} = C_{PD} \cdot V_{CC} \cdot f_{in} + I_{CC}$ .  $C_{PD}$  is used to determine the no-load dynamic power consumption:  $P_D = C_{PD} \cdot V_{CC}^2 \cdot f_{in} + I_{CC} \cdot V_{CC}$ .



### PROPAGATION DELAYS

$t_R = t_F = 2.5$  ns, 10% to 90%;  $f = 1$  MHz;  $t_W = 500$  ns

Figure 3. Switching Waveforms



$R_T = Z_{OUT}$  of pulse generator (typically 50  $\Omega$ )

Figure 4. Test Circuit

## NLX3G16

### ORDERING INFORMATION

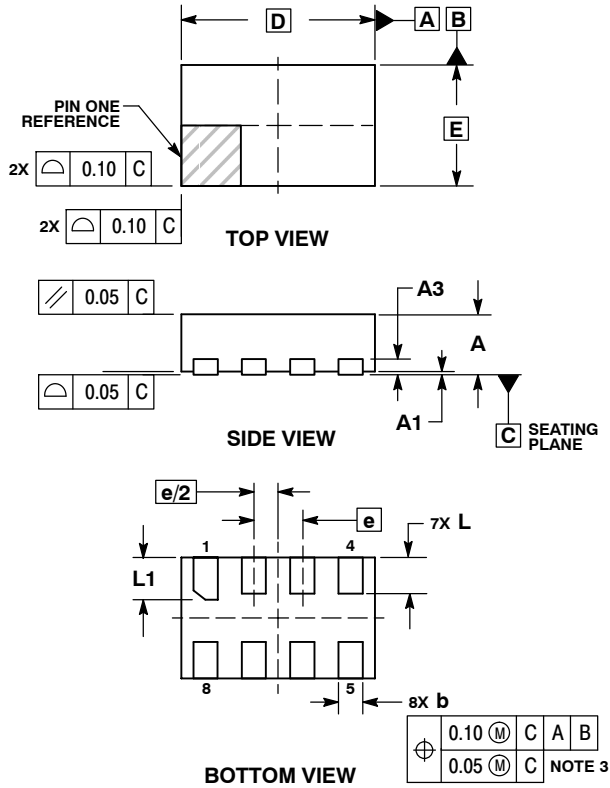
| Device         | Package                                | Shipping†          |
|----------------|----------------------------------------|--------------------|
| NLX3G16AMX1TCG | ULLGA8, 1.95 x 1.0, 0.5P<br>(Pb-Free)  | 3000 / Tape & Reel |
| NLX3G16BMX1TCG | ULLGA8, 1.6 x 1.0, 0.4P<br>(Pb-Free)   | 3000 / Tape & Reel |
| NLX3G16CMX1TCG | ULLGA8, 1.45 x 1.0, 0.35P<br>(Pb-Free) | 3000 / Tape & Reel |
| NLX3G16DMUTCG  | UDFN8, 1.95 x 1.0, 0.5P<br>(Pb-Free)   | 3000 / Tape & Reel |
| NLX3G16EMUTCG  | UDFN8, 1.6 x 1.0, 0.4P<br>(Pb-Free)    | 3000 / Tape & Reel |
| NLX3G16FMUTCG  | UDFN8, 1.45 x 1.0, 0.35P<br>(Pb-Free)  | 3000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# NLX3G16

## PACKAGE DIMENSIONS

UDFN8 1.6x1.0, 0.4P  
CASE 517BY  
ISSUE O

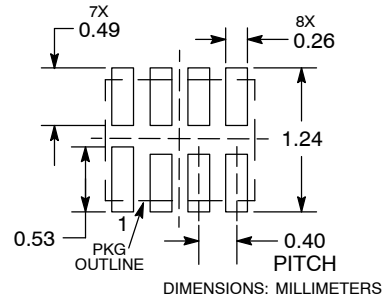


### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP.
4. PACKAGE DIMENSIONS EXCLUSIVE OF BURRS AND MOLD FLASH.

| DIM | MILLIMETERS |      |
|-----|-------------|------|
|     | MIN         | MAX  |
| A   | 0.45        | 0.55 |
| A1  | 0.00        | 0.05 |
| A3  | 0.13        | REF  |
| b   | 0.15        | 0.25 |
| D   | 1.60        | BSC  |
| E   | 1.00        | BSC  |
| e   | 0.40        | BSC  |
| L   | 0.25        | 0.35 |
| L1  | 0.30        | 0.40 |

### RECOMMENDED SOLDERING FOOTPRINT\*

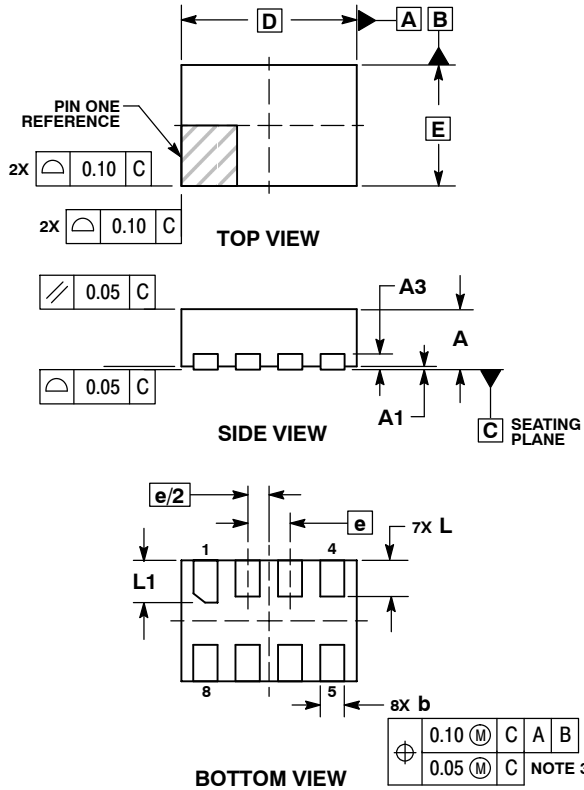


\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# NLX3G16

## PACKAGE DIMENSIONS

UDFN8 1.45x1.0, 0.35P  
CASE 517BZ  
ISSUE O

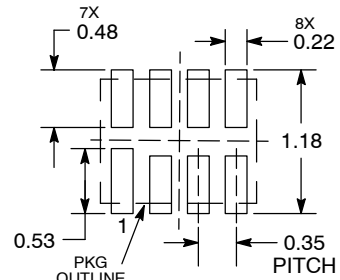


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| DIM | MILLIMETERS |      |
|-----|-------------|------|
|     | MIN         | MAX  |
| A   | 0.45        | 0.55 |
| A1  | 0.00        | 0.05 |
| A3  | 0.13        | REF  |
| b   | 0.15        | 0.25 |
| D   | 1.45        | BSC  |
| E   | 1.00        | BSC  |
| e   | 0.35        | BSC  |
| L   | 0.25        | 0.35 |
| L1  | 0.30        | 0.40 |

### RECOMMENDED SOLDERING FOOTPRINT\*



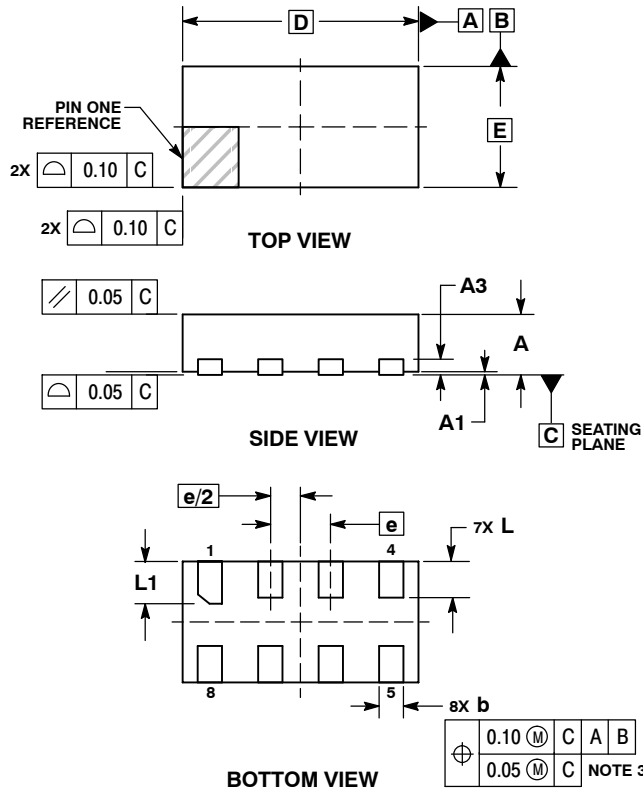
DIMENSIONS: MILLIMETERS

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# NLX3G16

## PACKAGE DIMENSIONS

UDFN8 1.95x1.0, 0.5P  
CASE 517CA  
ISSUE O

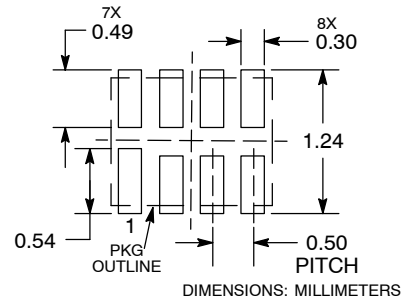


### NOTES:

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2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP.
4. PACKAGE DIMENSIONS EXCLUSIVE OF BURRS AND MOLD FLASH.

| MILLIMETERS |      |      |
|-------------|------|------|
| DIM         | MIN  | MAX  |
| A           | 0.45 | 0.55 |
| A1          | 0.00 | 0.05 |
| A3          | 0.13 | REF  |
| b           | 0.15 | 0.25 |
| D           | 1.95 | BSC  |
| E           | 1.00 | BSC  |
| e           | 0.50 | BSC  |
| L           | 0.25 | 0.35 |
| L1          | 0.30 | 0.40 |

### RECOMMENDED SOLDERING FOOTPRINT\*



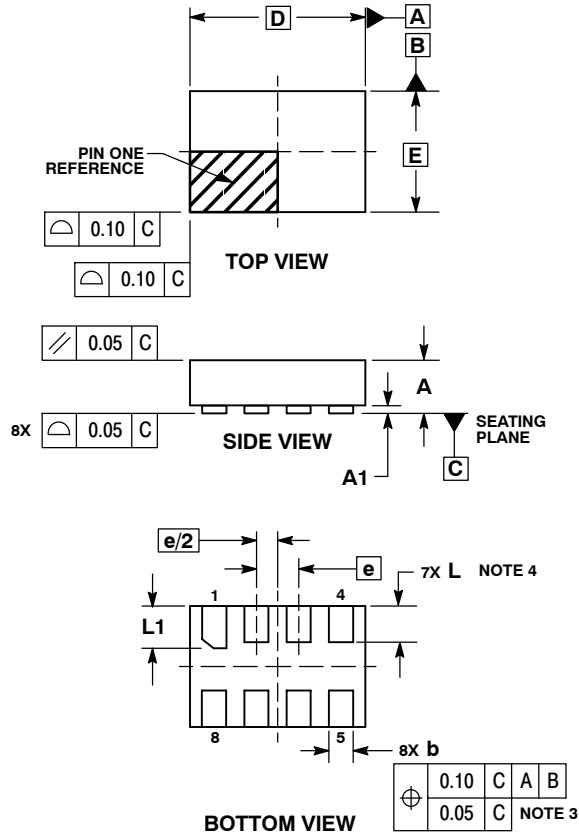
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# NLX3G16

## PACKAGE DIMENSIONS

ULLGA8 1.45x1.0, 0.35P  
CASE 613AA  
ISSUE A

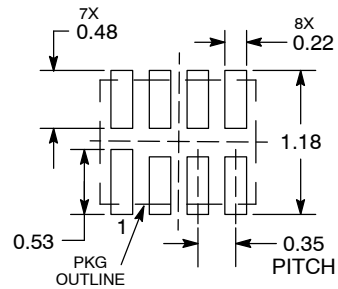


### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.
4. A MAXIMUM OF 0.05 PULL BACK OF THE PLATED TERMINAL FROM THE EDGE OF THE PACKAGE IS ALLOWED.

| MILLIMETERS |      |      |
|-------------|------|------|
| DIM         | MIN  | MAX  |
| A           | ---  | 0.40 |
| A1          | 0.00 | 0.05 |
| b           | 0.15 | 0.25 |
| D           | 1.45 | BSC  |
| E           | 1.00 | BSC  |
| e           | 0.35 | BSC  |
| L           | 0.25 | 0.35 |
| L1          | 0.30 | 0.40 |

### MOUNTING FOOTPRINT SOLDERMASK DEFINED\*



DIMENSIONS: MILLIMETERS

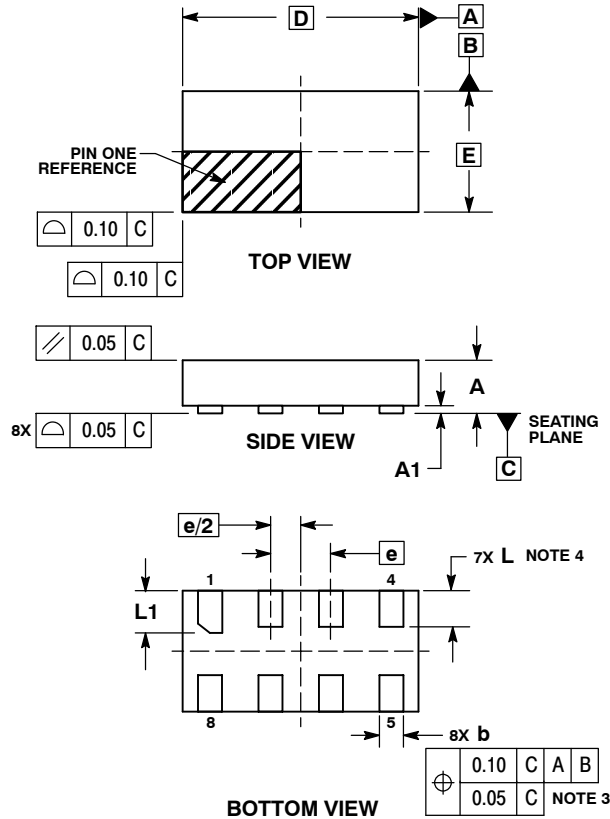
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# NLX3G16

## PACKAGE DIMENSIONS

ULLGA8 1.95x1.0, 0.5P  
CASE 613AC  
ISSUE A

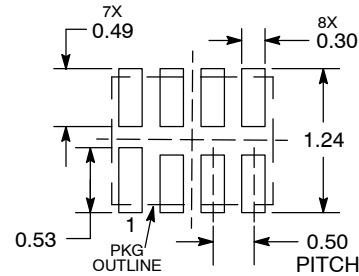


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4. A MAXIMUM OF 0.05 PULL BACK OF THE PLATED TERMINAL FROM THE EDGE OF THE PACKAGE IS ALLOWED.

| MILLIMETERS |      |      |
|-------------|------|------|
| DIM         | MIN  | MAX  |
| A           | ---  | 0.40 |
| A1          | 0.00 | 0.05 |
| b           | 0.15 | 0.25 |
| D           | 1.95 | BSC  |
| E           | 1.00 | BSC  |
| e           | 0.50 | BSC  |
| L           | 0.25 | 0.35 |
| L1          | 0.30 | 0.40 |

### MOUNTING FOOTPRINT SOLDERMASK DEFINED\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERM/D.

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